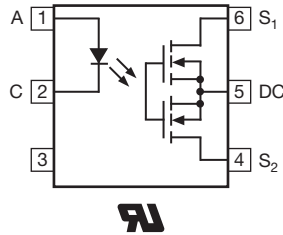




## 1 Form A Solid-State Relay (Normally Open)



### FEATURES

- Isolation test voltage 5300 V<sub>RMS</sub>
- Typical R<sub>ON</sub> 12 Ω
- Load voltage 200 V
- Load current 200 mA / 350 mA
- Clean bounce free switching
- Current limit protection
- Low power consumption
- Material categorization: for definitions of compliance please see [www.vishay.com/doc?99912](http://www.vishay.com/doc?99912)



**RoHS**  
COMPLIANT  
HALOGEN  
**FREE**  
**GREEN**  
(5-2008)

### DESCRIPTION

The LH1510 is an SPST normally open switch (1 Form A) that can replace electromechanical relays in many applications. The relay is constructed using a GaAlAs LED for actuation control and high reliable MOSFETs for the output switch. In addition, it employs current-limiting circuitry to provide overvoltage protection. The LH1510 provides current limiting also for unidirectional DC applications.

### APPLICATIONS

- General telecom switching
- Metering
- Security equipment
- Instrumentation
- Industrial controls
- Battery management systems
- Automatic test equipment

### AGENCY APPROVALS

- UL1577, file no. E52744

ORDERING INFORMATION												
L	H	1	5	1	0	#	#	#	T	R		
PART NUMBER						ELECTR. VARIATION		PACKAGE CONFIG.		TAPE AND REEL		
<b>PACKAGE</b>						<b>UL</b>						
SMD-6, tubes						LH1510AAB						
SMD-6, tape and reel						LH1510AABTR						
DIP-6, tubes						LH1510AT						



ABSOLUTE MAXIMUM RATINGS ( $T_{amb} = 25\text{ }^{\circ}\text{C}$ , unless otherwise specified)				
PARAMETER	CONDITION	SYMBOL	VALUE	UNIT
<b>INPUT</b>				
IRED continuous forward current		$I_F$	50	mA
IRED reverse voltage		$V_R$	5	V
Input power dissipation		$P_{diss}$	80	mW
<b>OUTPUT</b>				
DC or peak AC load voltage		$V_L$	200	V
Continuous load current (AC/DC configuration)		$I_L$	200	mA
Continuous load current (DC only configuration)		$I_L$	350	mA
SSR output power dissipation (continuous)		$P_{diss}$	550	mW
<b>SSR</b>				
Ambient temperature range		$T_{amb}$	-40 to +85	$^{\circ}\text{C}$
Storage temperature range		$T_{stg}$	-40 to +150	$^{\circ}\text{C}$
Soldering temperature	$t = 10\text{ s max.}$	$T_{sld}$	260	$^{\circ}\text{C}$

**Note**

- Stresses in excess of the absolute maximum ratings can cause permanent damage to the device. Functional operation of the device is not implied at these or any other conditions in excess of those given in the operational sections of this document. Exposure to absolute maximum ratings for extended periods of the time can adversely affect reliability

ELECTRICAL CHARACTERISTICS ( $T_{amb} = 25\text{ }^{\circ}\text{C}$ , unless otherwise specified)						
PARAMETER	TEST CONDITION	SYMBOL	MIN.	TYP.	MAX.	UNIT
<b>INPUT</b>						
IRED forward current, switch turn-on	$I_L = 100\text{ mA}$ , $t = 10\text{ ms}$	$I_{Fon}$	-	0.4	2	mA
IRED forward current, switch turn-off	$V_L = \pm 200\text{ V}$	$I_{Foff}$	0.05	0.35	-	mA
IRED forward voltage	$I_F = 10\text{ mA}$	$V_F$	1.15	1.36	1.45	V
<b>OUTPUT</b>						
On-resistance (AC/DC configuration)	$I_F = 5\text{ mA}$ , $I_L = 50\text{ mA}$	$R_{ON}$	6	12	15	$\Omega$
On-resistance (DC only configuration)	$I_F = 5\text{ mA}$ , $I_L = 100\text{ mA}$	$R_{ON}$	1.5	3.2	3.75	$\Omega$
Off-resistance	$I_F = 0\text{ mA}$ , $V_L = \pm 100\text{ V}$	$R_{OFF}$	0.5	5000	-	$\text{G}\Omega$
Off-state leakage current	$I_F = 0\text{ mA}$ , $V_L = \pm 100\text{ V}$	$I_O$	-	< 1	200	nA
	$I_F = 0\text{ mA}$ , $V_L = \pm 200\text{ V}$	$I_O$	-	< 1	1000	nA
Output capacitance (AC/DC configuration)	$I_F = 0\text{ mA}$ , $V_L = 1\text{ V}$ , 1 MHz	$C_O$	-	39	-	pF
	$I_F = 0\text{ mA}$ , $V_L = 50\text{ V}$ , 1 MHz	$C_O$	-	6	-	pF
Current limit (AC/DC configuration)	$I_F = 5\text{ mA}$ , $t = 5\text{ ms}$ , $V_L = \pm 6\text{ V}$	$I_{limit}$	300	440	550	mA
Current limit (DC only configuration)	$I_F = 5\text{ mA}$ , $t = 5\text{ ms}$ , $V_L = \pm 6\text{ V}$	$I_{limit}$	600	870	1100	mA
<b>TRANSFER</b>						
Capacitance (input to output)	$V_{IO} = 1\text{ V}$	$C_{IO}$	-	0.4	-	pF

**Note**

- Minimum and maximum values are testing requirements. Typical values are characteristics of the device and are the result of engineering evaluations. Typical values are for information only and are not part of the testing requirements

## PIN CONFIGURATION



Fig. 1 - Pin Configuration

SWITCHING CHARACTERISTICS ( $T_{amb} = 25\text{ }^{\circ}\text{C}$ , unless otherwise specified)						
PARAMETER	TEST CONDITION	SYMBOL	MIN.	TYP.	MAX.	UNIT
Turn-on time	$I_F = 5\text{ mA}$ , $I_L = 50\text{ mA}$	$t_{on}$	-	0.20	2	ms
Turn-off time	$I_F = 5\text{ mA}$ , $I_L = 50\text{ mA}$	$t_{off}$	-	0.03	2	ms



Fig. 2 - Timing Schematic

SAFETY AND INSULATION RATINGS				
PARAMETER	CONDITION	SYMBOL	VALUE	UNIT
Climatic classification	According to IEC 68 part 1		40 / 85 / 21	
Pollution degree	According to DIN VDE 0109		2	
Comparative tracking index	Insulation group IIIa	CTI	175	
Maximum rated withstanding isolation voltage	According to UL1577, $t = 1\text{ min}$	$V_{ISO}$	5300	$V_{RMS}$
Maximum transient isolation voltage	According to DIN EN 60747-5-5	$V_{IOTM}$	8000	$V_{peak}$
Maximum repetitive peak isolation voltage	According to DIN EN 60747-5-5	$V_{IORM}$	890	$V_{peak}$
Insulation resistance	$V_{IO} = 500\text{ V}$ , $T_{amb} = 25\text{ }^{\circ}\text{C}$	$R_{IO}$	$\geq 10^{12}$	$\Omega$
	$V_{IO} = 500\text{ V}$ , $T_{amb} = 100\text{ }^{\circ}\text{C}$	$R_{IO}$	$\geq 10^{11}$	$\Omega$
Output safety power		$P_{SO}$	700	mW
Input safety current		$I_{SI}$	240	mA
Safety temperature		$T_S$	175	$^{\circ}\text{C}$
Creepage distance			$\geq 7$	mm
Clearance distance			$\geq 7$	mm
Insulation thickness		DTI	$\geq 0.4$	mm
Input to output test voltage, method B	$V_{IORM} \times 1.875 = V_{PR}$ , 100 % production test with $t_M = 1\text{ s}$ , partial discharge $< 5\text{ pC}$	$V_{PR}$	1669	$V_{peak}$
Input to output test voltage, method A	$V_{IORM} \times 1.6 = V_{PR}$ , 100 % sample test with $t_M = 10\text{ s}$ , partial discharge $< 5\text{ pC}$	$V_{PR}$	1424	$V_{peak}$

### Note

- As per IEC 60747-5-5, § 7.4.3.8.2, this optocoupler is suitable for "safe electrical insulation" only within the safety ratings. Compliance with the safety ratings shall be ensured by means of protective circuits

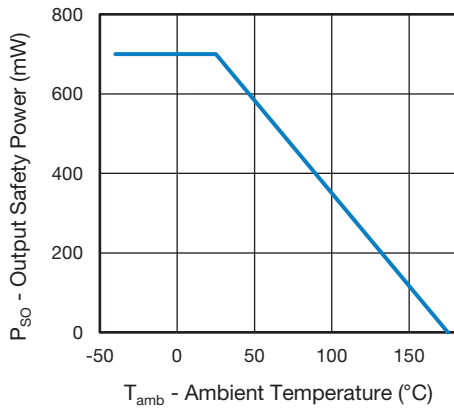


Fig. 3 - Output Safety Power vs. Ambient Temperature

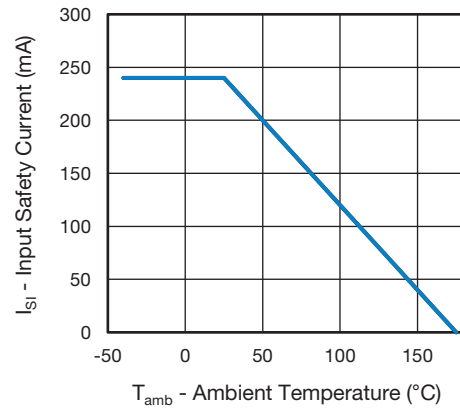


Fig. 4 - Input Safety Current vs. Ambient Temperature

**TYPICAL CHARACTERISTICS** ( $T_{amb} = 25\text{ }^{\circ}\text{C}$ , unless otherwise specified)

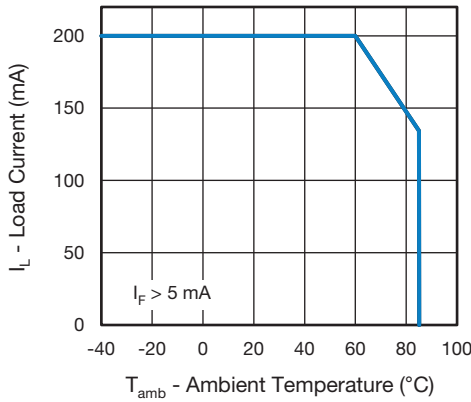


Fig. 5 - Load Current vs. Ambient Temperature

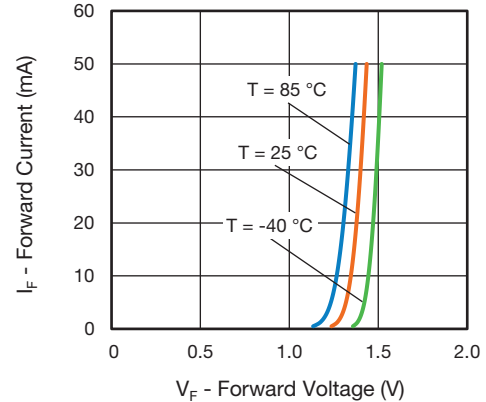


Fig. 7 - Forward Current vs. Forward Voltage

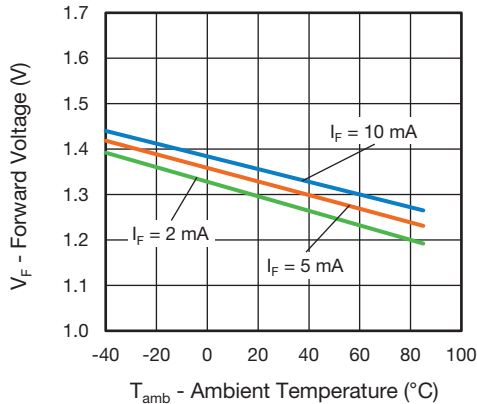


Fig. 6 - Forward Voltage vs. Ambient Temperature

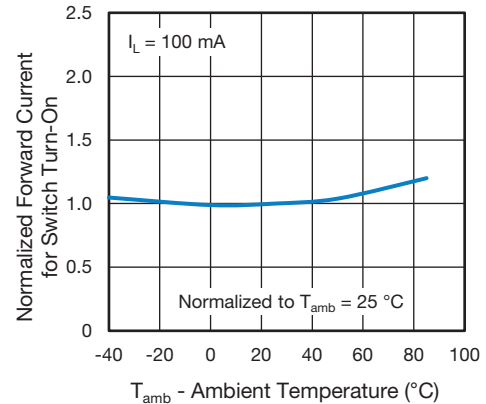


Fig. 8 - Normalized Forward Current for Switch Turn-On vs. Ambient Temperature

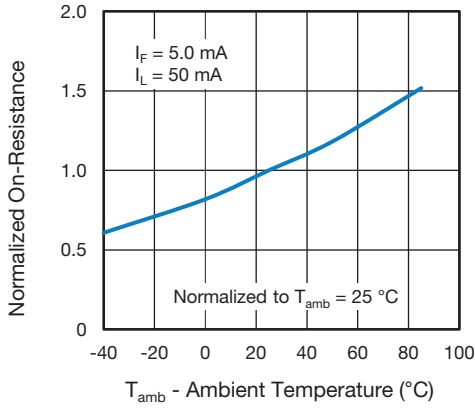


Fig. 9 - Normalized On-Resistance vs. Ambient Temperature

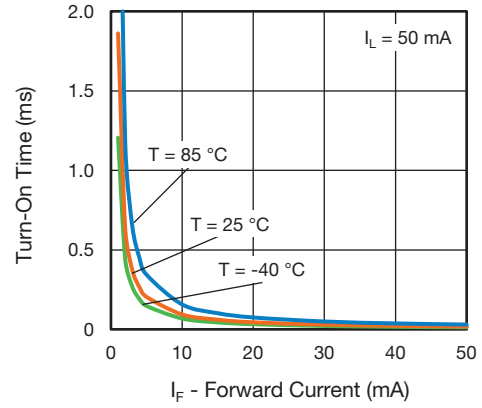


Fig. 12 - Turn-On Time vs. Forward Current

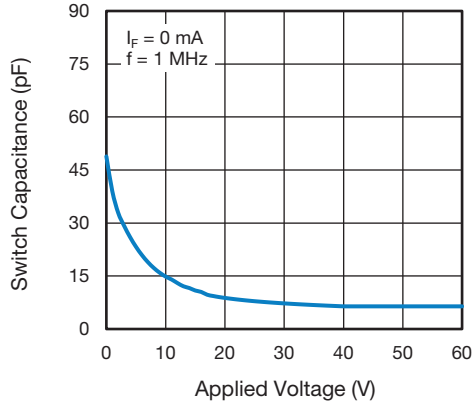


Fig. 10 - Switch Capacitance vs. Applied Voltage

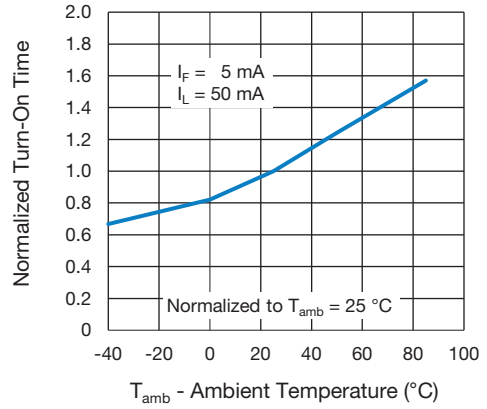


Fig. 13 - Normalized Turn-On Time vs. Ambient Temperature

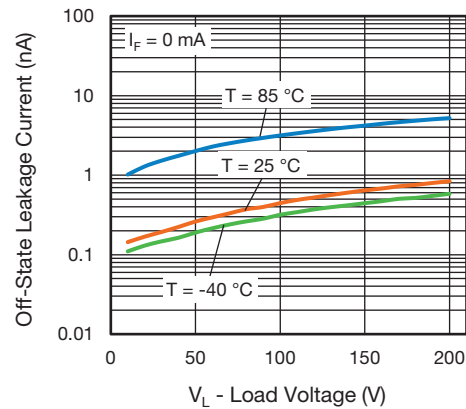


Fig. 11 - Off-State Leakage Current vs. Load Voltage

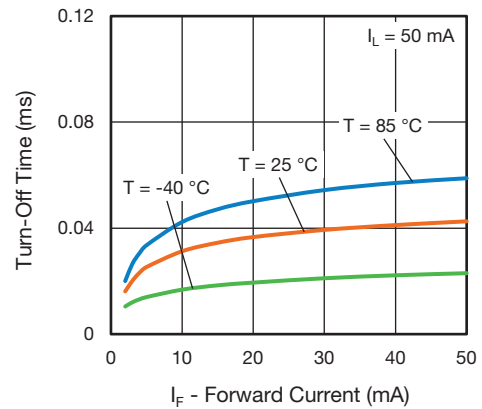


Fig. 14 - Turn-Off Time vs. Forward Current



Fig. 15 - Normalized Turn-Off Time vs. Ambient Temperature

**PACKAGE DIMENSIONS** (in millimeters)

**SMD-6**

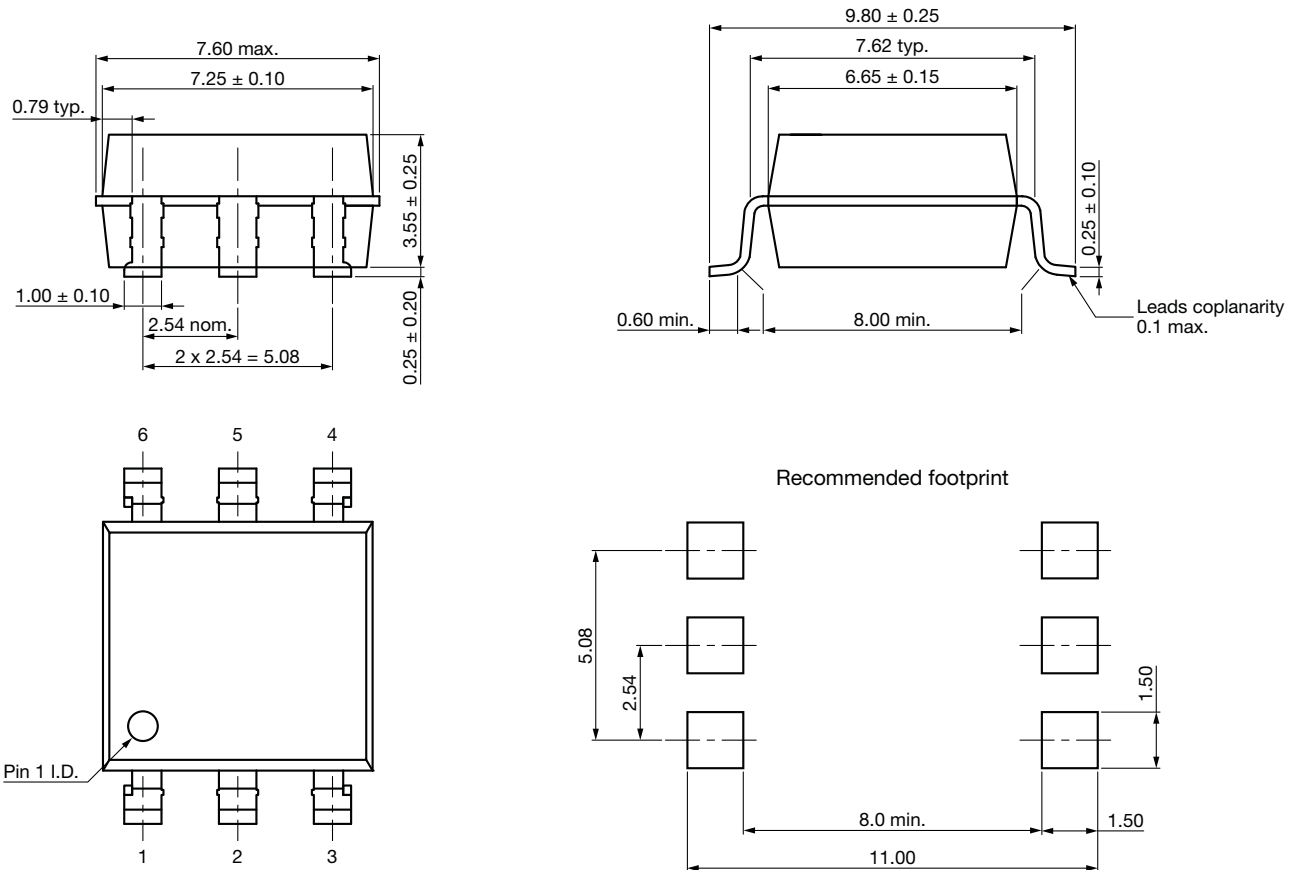


Fig. 16 - Package Drawings



## DIP-6



Fig. 17 - Package Drawings

## PACKAGE MARKING

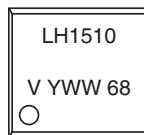


Fig. 18 - LH1510

### Note

- Tape and reel suffix (TR) is not part of the package marking

## PACKING INFORMATION (in millimeters)

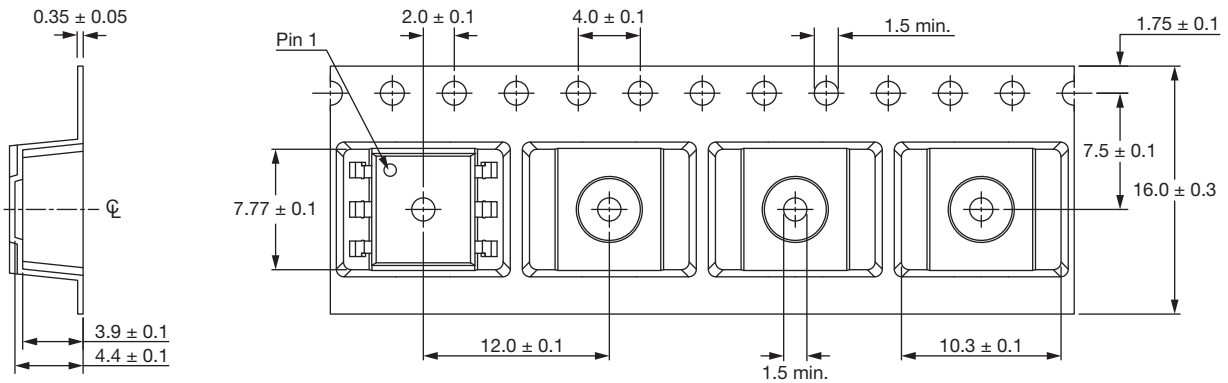
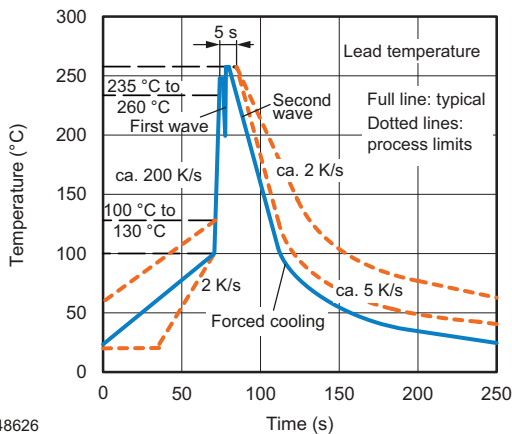


Fig. 19 - Tape and Reel Packing

TAPE AND REEL PACKING	
TYPE	UNITS/REEL
SMD-6	1000

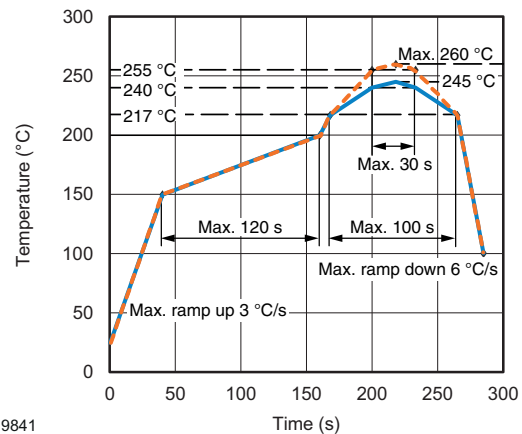
TUBE PACKING			
TYPE	UNITS/TUBE	TUBES/BOX	UNITS/BOX
SMD-6	50	40	2000
DIP-6	50	40	2000

## SOLDER PROFILES



948626

Fig. 20 - Wave Soldering Double Wave Profile According to J-STD-020 for DIP Devices



19841

Fig. 21 - Lead (Pb)-free Reflow Solder Profile According to J-STD-020 for SMD Devices

## HANDLING AND STORAGE CONDITIONS

ESD level: HBM class 2

Floor life: unlimited

Conditions:  $T_{amb} < 30\text{ °C}$ , RH < 60 %

Moisture sensitivity level 1, according to J-STD-020





## Footprint and Schematic Information for LH1510AAB, LH1510AABTR, LH1510AT

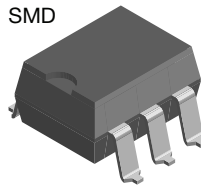
The footprint and schematic symbols for the following parts can be accessed using the associated links. They are available in Eagle, Altium, KiCad, OrCAD / Allegro, Pulsonix, and PADS.

Note that the 3D models for these parts can be found on the Vishay product page.

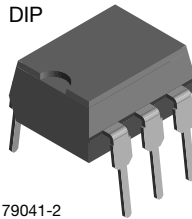
PART NUMBER	FOOTPRINT / SCHEMATIC
LH1510AAB	<a href="http://www.snapeda.com/parts/LH1510AAB/Vishay/view-part">www.snapeda.com/parts/LH1510AAB/Vishay/view-part</a>
LH1510AABTR	<a href="http://www.snapeda.com/parts/LH1510AABTR/Vishay/view-part">www.snapeda.com/parts/LH1510AABTR/Vishay/view-part</a>
LH1510AT	<a href="http://www.snapeda.com/parts/LH1510AT/Vishay/view-part">www.snapeda.com/parts/LH1510AT/Vishay/view-part</a>

For technical issues and product support, please contact [optocoupleranswers@vishay.com](mailto:optocoupleranswers@vishay.com).

SMD



DIP



i179041-2



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